



# MP8785

## CMOS 8-Bit High Speed Analog-to-Digital Converter

March 1998-3

### FEATURES

- 8-Bit Resolution
- 20 MHz Sampling Rate
- $DNL = \pm 1/2$  LSB,  $INL = \pm 1$  LSB (typ)
- Internal S/H Function
- Single Supply: 5 V
- $V_{IN}$  DC Range: 0 V to  $V_{DD}$
- $V_{REF}$  DC Range: 1 V to  $V_{DD}$
- Low Power: 85 mW typ. (excluding reference)
- Latch-Up Free
- ESD Protection: 2000 V Minimum

### FEATURES (CONT D)

- Monotonic. No Missing Codes
- 20 Pin Package Available: MP8775
- Power Down Available: MP8786
- 3 V Version: MP87L85

### APPLICATIONS

- Digital Color Copiers
- Cellular Telephones
- CCD s and Scanners
- Video Capture Boards

### GENERAL DESCRIPTION

The MP8785 is an 8-bit Analog-to-Digital Converter. Designed using an advanced 5 V CMOS process, this part offers excellent performance, low power consumption and latch-up free operation.

This device uses a two-step flash architecture to maintain low power consumption at high conversion rates. The input circuitry of the MP8785 includes an on-chip S/H function which allows the user to digitize analog input signals between AGND and  $AV_{DD}$ . Careful design and chip layout have achieved a low analog input capacitance. This reduces kickback and eases the requirements of the buffer/amplifier used to drive the MP8785.

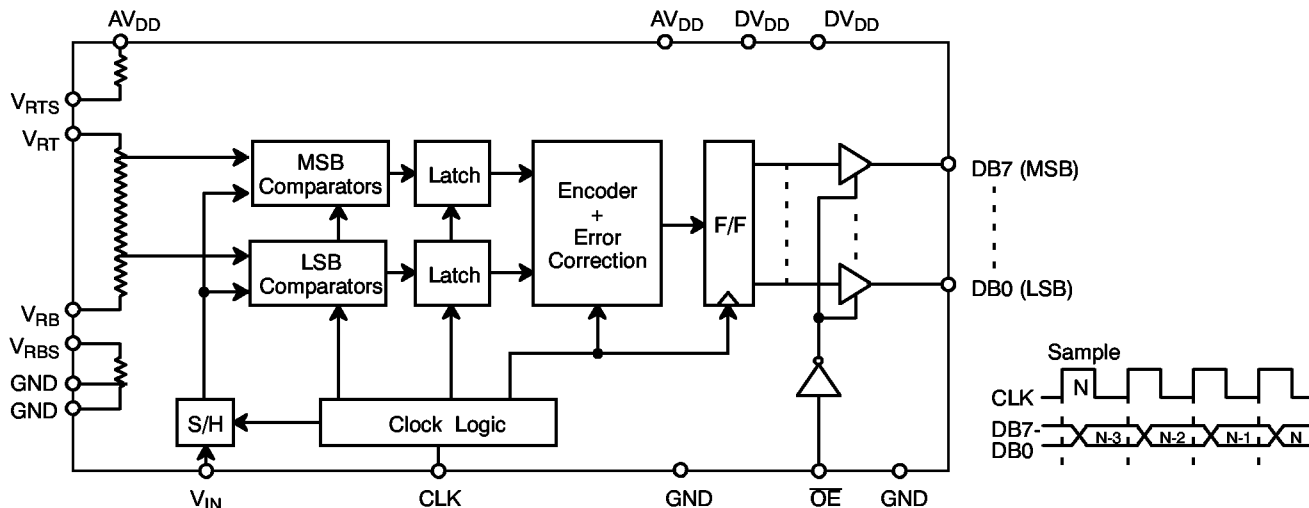
The designer can choose the internally generated reference voltages by connecting  $V_{RB}$  to  $V_{RBS}$  and  $V_{RT}$  to

$V_{RTS}$ , or provide external reference voltages to the  $V_{RB}$  and  $V_{RT}$  pins. The internal reference generates 0.6 V at  $V_{RB}$  and 2.6 V at  $V_{RT}$ . Providing external reference voltages allows easy interface to any input signal range between AGND and  $AV_{DD}$ . This also allows the system to adjust these voltages to cancel zero scale and full scale errors, or to change the input range as needed.

The device operates from a single +5 V supply. Power consumption is 85 mW at FS = 20 MHz.

Specified for operation over the commercial / industrial (-40 to +85°C) temperature range, the MP8785 is available in Plastic dual-in-line (PDIP) and Surface Mount (SOIC) packages in EIAJ and Jedec.

### SIMPLIFIED BLOCK AND TIMING DIAGRAM

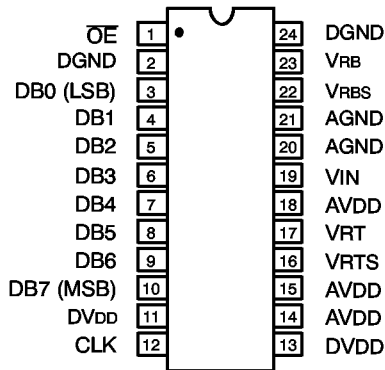


## ORDERING INFORMATION

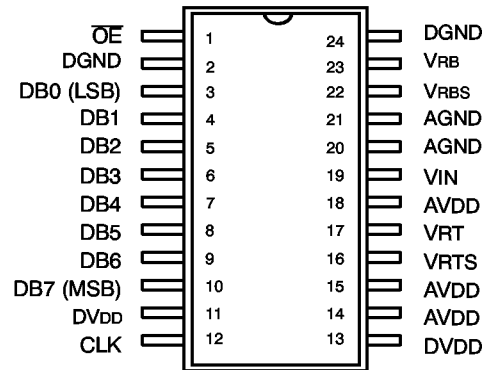
Package Type	Temperature Range	Part No.	DNL (LSB)	INL (LSB)
SOIC (EIAJ)	-40 to +85°C	MP8785AR	±3/4	1 1/2
SOIC (Jedec)	-40 to +85°C	MP8785AS	±3/4	1 1/2
Plastic Dip (0.300 )	-40 to +85°C	MP8785AN	±3/4	1 1/2

## PIN CONFIGURATIONS

See Packaging Section for Package Dimensions



24 Pin PDIP (0.300 )



24 Pin SOIC (EIAJ, 0.300 )  
24 Pin SOIC (Jedec, 0.300 )

## PIN OUT DEFINITIONS

PIN NO.	NAME	DESCRIPTION
1	OE	Output Enable
2	DGND	Digital Ground
3	DB0	Data Output Bit 0 (LSB)
4	DB1	Data Output Bit 1
5	DB2	Data Output Bit 2
6	DB3	Data Output Bit 3
7	DB4	Data Output Bit 4
8	DB5	Data Output Bit 5
9	DB6	Data Output Bit 6
10	DB7	Data Output Bit 7 (MSB)
11	DVDD	Digital Power Supply
12	CLK	Sampling Clock Input

PIN NO.	NAME	DESCRIPTION
13	DVDD	Digital Power Supply
14	AVDD	Analog Power Supply
15	AVDD	Analog Power Supply
16	VRTS	Generates 2.6 V if tied to V <sub>RT</sub>
17	VRT	Top Reference
18	AVDD	Analog Power Supply
19	VIN	Analog Input
20	AGND	Analog Ground
21	AGND	Analog Ground
22	VRBS	Generates 0.6 V if tied to V <sub>RB</sub>
23	VRB	Bottom Reference
24	DGND	Digital Ground

## ELECTRICAL CHARACTERISTICS TABLE

Unless Otherwise Specified:  $V_{DD} = DV_{DD} = 5\text{ V}$ ,  $FS = 15\text{ MHz}$  (50% Duty Cycle),  
 $V_{RT} = 2.6\text{ V}$ ,  $V_{RB} = 0.6\text{ V}$ ,  $T_A = 25^\circ\text{C}$

Parameter	Symbol	25°C			Units	Test Conditions/Comments
		Min	Typ	Max		
<b>KEY FEATURES</b>						
Resolution		8				Bits
Max. Sampling Rate	FS	15	20		MHz	
<b>ACCURACY (A Grade)<sup>1</sup></b>						
Differential Non-Linearity	DNL			$\pm 3/4$	LSB	@ 15 MHz
Differential Non-Linearity	DNL			$\pm 1/2$	LSB	@ 10 MHz
Integral Non-Linearity	INL			$\pm 1\ 1/2$	LSB	Best Fit Line (Max INL - Min INL)/2
Zero Scale Error	EZS		$\pm 3$		LSB	
Full Scale Error	EFS		$\pm 3$		LSB	
<b>REFERENCE VOLTAGES</b>						
Positive Ref. Voltage <sup>3</sup>	$V_{RT}$		2.6	$AV_{DD}$	V	$V_{REF} = V_{RT} - V_{RB}$
Negative Ref. Voltage <sup>3</sup>	$V_{RB}$	AGND	0.6		V	
Differential Ref. Voltage <sup>3</sup>	$V_{REF}$	1.0		$AV_{DD}$	V	
Ladder Resistance	$R_L$	245	350	500	$\Omega$	
Ladder Temp. Coefficient	$R_{TCO}$		2000		ppm/°C	
Self Bias 1						
Short $V_{RB}$ and $V_{RBS}$	$V_{RB}$		0.6		V	
Short $V_{RT}$ and $V_{RTS}$	$V_{RT}-V_{RB}$		2		V	
Self Bias 2						
$V_{RB} = \text{AGND}$ , Short $V_{RT}$ and $V_{RTS}$	$V_{RT}$		2.3		V	
<b>ANALOG INPUT</b>						
Input Bandwidth (-1 dB) <sup>4</sup>	BW		14		MHz	
Input Voltage Range	$V_{IN}$	$V_{RB}$		$V_{RT}$	V	
Input Capacitance <sup>5</sup>	$C_{IN}$		16		pF	
Aperture Delay	$t_{AP}$	15	20	25	ns	
<b>DIGITAL INPUTS</b>						
Logical 1 Voltage	$V_{IH}$	4.0			V	$V_{IN} = \text{DGND to } DV_{DD}$
Logical 0 Voltage	$V_{IL}$			1.0	V	
DC Leakage Currents <sup>6</sup>	$I_{IN}$					
CLK			5		$\mu\text{A}$	
$\overline{\text{OE}}$			5		$\mu\text{A}$	
Input Capacitance			5		pF	
Clock Timing (See Figure 1.) <sup>7</sup>						
Clock Period <sup>3</sup>	1/FS		50		ns	
High Pulse Width <sup>3</sup>	$t_{PWH}$		25		ns	
Low Pulse Width <sup>3</sup>	$t_{PWL}$		25		ns	
<b>DIGITAL OUTPUTS</b>						
Logical 1 Voltage	$V_{OH}$	4.5			V	$C_{OUT} = 15\text{ pF}$ $I_{LOAD} = 4\text{ mA}$ $I_{LOAD} = 4\text{ mA}$ $V_{OUT} = \text{DGND to } DV_{DD}$
Logical 0 Voltage	$V_{OL}$			0.4	V	
3-state Leakage	$I_{OZ}$		10		$\mu\text{A}$	
Data Valid Delay <sup>2, 8</sup>	$t_{DL}$	18	20	25	ns	
Data Enable Delay <sup>2</sup>	$t_{DEN}$	16	20	25	ns	
Data 3-state Delay <sup>2</sup>	$t_{DHZ}$	10	12	15	ns	

## ELECTRICAL CHARACTERISTICS TABLE (CONT D)

Description	Symbol	25°C			Units	Conditions
		Min	Typ	Max		
<b>AC PARAMETERS</b>						
Differential Gain Error	dg		2		%	FS = 4 x NTSC
Differential Phase Error	d <sub>ph</sub>		1		Degree	FS = 4 x NTSC
<b>POWER SUPPLIES</b>						
Operating Voltage (AV <sub>DD</sub> , DV <sub>DD</sub> ) <sup>9</sup>	V <sub>DD</sub>	4.5	5	5.5	V	Does not include ref. current
Current (AGND + DGND)	I <sub>DD</sub>		17	25	mA	

**Notes:**

- <sup>1</sup> Tester measures code transitions by dithering the voltage of the analog input (V<sub>IN</sub>). The difference between the measured and the ideal code width (V<sub>REF</sub>/256) is the DNL error (Figure 3). The INL error is the maximum distance (in LSBs) from the best fit line to any transition voltage (Figure 4). Accuracy is a function of the sampling rate (FS).
- <sup>2</sup> Guaranteed. Not tested.
- <sup>3</sup> Specified values guarantee functionality. Refer to other parameters for accuracy.
- <sup>4</sup> -1 dB bandwidth is a measure of performance of the A/D input stage (S/H + amplifier). Refer to other parameters for accuracy within the specified bandwidth.
- <sup>5</sup> See V<sub>IN</sub> input equivalent circuit (Figure 5). Switched capacitor analog input requires driver with low output resistance.
- <sup>6</sup> All inputs have diodes to DV<sub>DD</sub> and DGND. Input DC currents will not exceed specified limits for any input voltage between DGND and DV<sub>DD</sub>.
- <sup>7</sup> t<sub>R</sub>, t<sub>F</sub> should be limited to >5 ns for best results.
- <sup>8</sup> Depends on the RC load connected to the output pin.
- <sup>9</sup> AGND & DGND pins are connected through the silicon substrate. Connect together at the package and to the analog ground plane.

Specifications are subject to change without notice

## ABSOLUTE MAXIMUM RATINGS (TA = +25°C unless otherwise noted)<sup>1, 2, 3</sup>

V <sub>DD</sub> to GND	7 V	Storage Temperature	-65 to +150°C
V <sub>RT</sub> & V <sub>RB</sub>	V <sub>DD</sub> +0.5 to GND -0.5 V	Lead Temperature (Soldering 10 seconds)	+300°C
V <sub>IN</sub>	V <sub>DD</sub> +0.5 to GND -0.5 V	Package Power Dissipation Rating @ 75°C	
All Inputs	V <sub>DD</sub> +0.5 to GND -0.5 V	PDIP, SOIC	850mW
All Outputs	V <sub>DD</sub> +0.5 to GND -0.5 V	Derates above 75°C	12mW/°C

**Notes**

- <sup>1</sup> Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation at or above this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.
- <sup>2</sup> Any input pin which can see a value outside the absolute maximum ratings should be protected by Schottky diode clamps (HP5082-2835) from input pin to the supplies. All inputs have protection diodes which will protect the device from short transients outside the supplies of less than 100mA for less than 100µs.
- <sup>3</sup> V<sub>DD</sub> refers to AV<sub>DD</sub> and DV<sub>DD</sub>. GND refers to AGND and DGND.

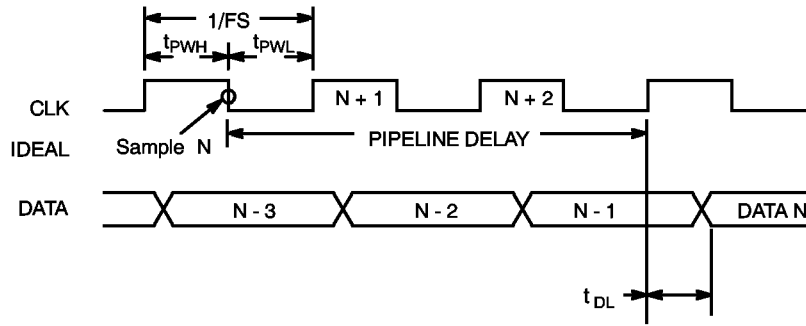


Figure 1. MP8785 Timing Diagram

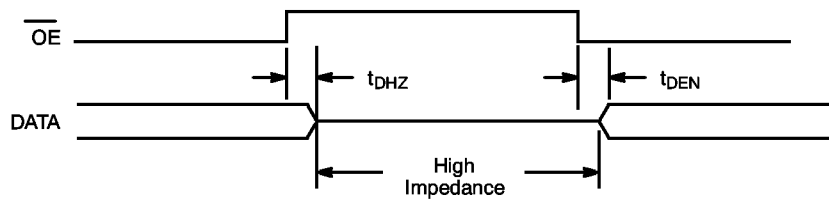


Figure 2. Output Enable/Disable Timing Diagram

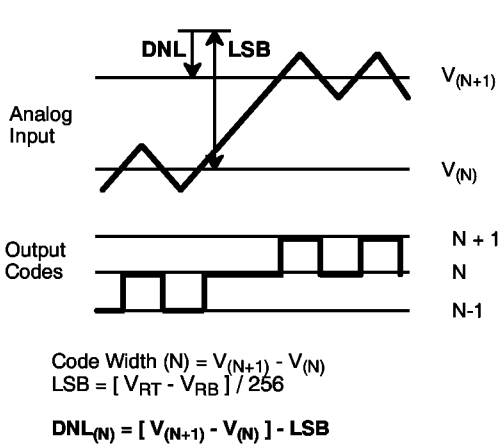


Figure 3. DNL Measurement

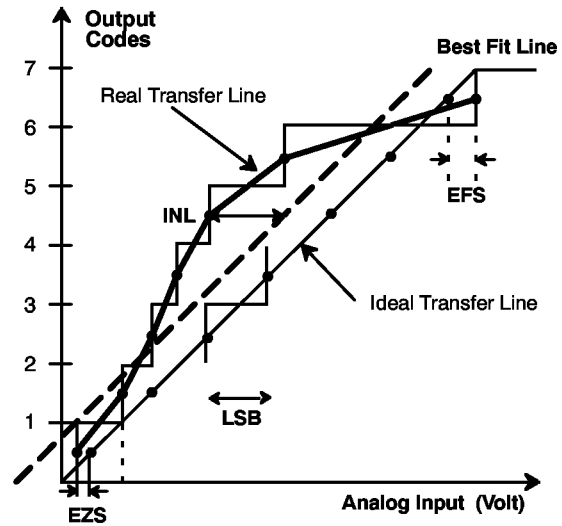


Figure 4. INL Error Calculation



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